



RE936-08

- Multiadapter TSSOP24 & SSOP24
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for TSSOP24 & SSOP24 with 0.65 mm pitch
- Hole spacing 2.54 mm
- Two experimenting areas with 2 x 3 square pads 2.20 x 2.20 mm
- Shield pad & cooling pad
- Size 31.75 x 19.05 mm